SP8K3FRA

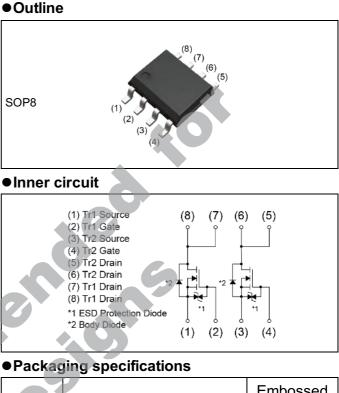
30V Nch+Nch Power MOSFET

Datasheet

V _{DSS}	30V
R _{DS(on)} (Max.)	24mΩ
ا _D	±7.0A
P _D	2.0W

Features

- 1) Low on resistance
- 2) Small Surface Mount Package (SOP8)
- 3) Pb-free lead plating ; RoHS compliant
- 4) AEC-Q101 Qualified



Application

Switching

Ø	Packing	Embossed Tape
	Reel size (mm)	330
Туре	Tape width (mm)	12
	Quantity (pcs)	2500
	Taping code	ТВ
	Marking	SP8K3

• Absolute maximum ratings ($T_a = 25^{\circ}C$,unless otherwise specified) <Tr1 and Tr2>

econt.

Parameter	Symbol	Value	Unit
Drain - Source voltage	V _{DSS}	30	V
Continuous drain current	I _D	±7.0	А
Pulsed drain current	I _{DP} *1	±28	А
Gate - Source voltage	V _{GSS}	±20	V
	P _D ^{*2}	2.0	\\\/
Power dissipation (total)	P _D *3	1.4	W
Junction temperature	T _j	150	°C
Operating junction and storage temperature range	T _{stg}	-55 to +150	°C

•Thermal resistance

Deremeter	Symbol	Values			Unit
Parameter	Symbol	Min.	Тур.	Max.	Unit
Thermal registered innotion embient (total)	R_{thJA}^{*2}	-	-	62.5	°C/W
Thermal resistance, junction - ambient (total)	R_{thJA}^{*3}	-	-	89.2	

•Electrical characteristics (T_a = 25°C) <Tr1 and Tr2>

Deverenter	Symbol Conditions		Values			Linit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 1mA	30	-	-	v
Breakdown voltage	$\Delta V_{(BR)DSS}$	I _D = 1mA	-	29	-	mV/°C
temperature coefficient	ΔT_j	referenced to 25°C		20		
Zero gate voltage drain current	I _{DSS}	V _{DS} = 30V, V _{GS} = 0V		-	1	μA
Gate - Source leakage current	I _{GSS}	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	-	-	±10	μA
Gate threshold voltage	V _{GS(th)}	V _{DS} = 10V, I _D = 1mA	1.0	-	2.5	V
Gate threshold voltage temperature coefficient	$\frac{\Delta V_{GS(th)}}{\Delta T_{j}}$	I _D = 1mA referenced to 25°C	-	-1.6	-	mV/°C
		V _{GS} = 10V, I _D = 7A	-	17	24	
Static drain - source on - state resistance	R _{DS(on)} *4	V _{GS} = 4.5V, I _D = 7A	-	23	33	mΩ
		V _{GS} = 4.0V, I _D = 7A	-	25	35	
Gate resistance	R _G	f = 1MHz, open drain	-	4.4	-	Ω
Forward Transfer Admittance	Y _{fs} *4	V _{DS} = 10V, I _D = 7A	5.0	-	-	S

*1 Pw \leq 10µs, Duty cycle \leq 1%

- *2 Mounted on a ceramic board (30×30×0.8mm)
- *3 Mounted on a FR4 (25×25×0.8mm)
- *4 Pulsed



•Electrical characteristics (T_a = 25°C) <Tr1 and Tr2>

Deveneeter	Currents et	Conditions	Values			Linit	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Input capacitance	C _{iss}	V _{GS} = 0V	-	600	-		
Output capacitance	C _{oss}	V _{DS} = 10V	-	200	-	pF	
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	120	-		
Turn - on delay time	t _{d(on)} *4	$V_{DD} \simeq 15 V, V_{GS} = 10 V$	-	8	-		
Rise time	t _r *4	I _D = 3.5A	-	10	-		
Turn - off delay time	$t_{d(off)}^{*4}$	R _L = 4.29Ω	-0	37	-	ns	
Fall time	t_{f}^{*4}	R _G = 10Ω	<u>_</u>	11	-		
 Gate charge characteristics 	(T _a = 25°C	c) <tr1 and="" tr2=""></tr1>		~			

•Gate charge characteristics ($T_a = 25^{\circ}C$) <Tr1 and Tr2>

Parameter	Symbol	Conditions		Values		Unit
	Symbol	Conditions	Min.	Тур.	Max.	Unit
Total gate charge	Q_g^*4		-	8.4	11.8	
Gate - Source charge	Q _{gs} *4	V _{DD} ≃ 15V, I _D = 7A V _{GS} = 5V	-	1.9	-	nC
Gate - Drain charge	Q _{gd} *4		-	3.3	-	

•Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

<Tr1 and Tr2>

Parameter	Symbol Conditions		Values			Unit
	Symbol	Conditions	Min.	Тур.	Max.	Unit
Continuous forward current	۱ _s	T - 25°0	-	-	1.6	^
Pulse forward current	I _{SP} *1	T _a = 25℃	-	-	6.4	A
Forward voltage	V _{SD} *4	V _{GS} = 0V, I _S = 6.4A	-	-	1.2	V



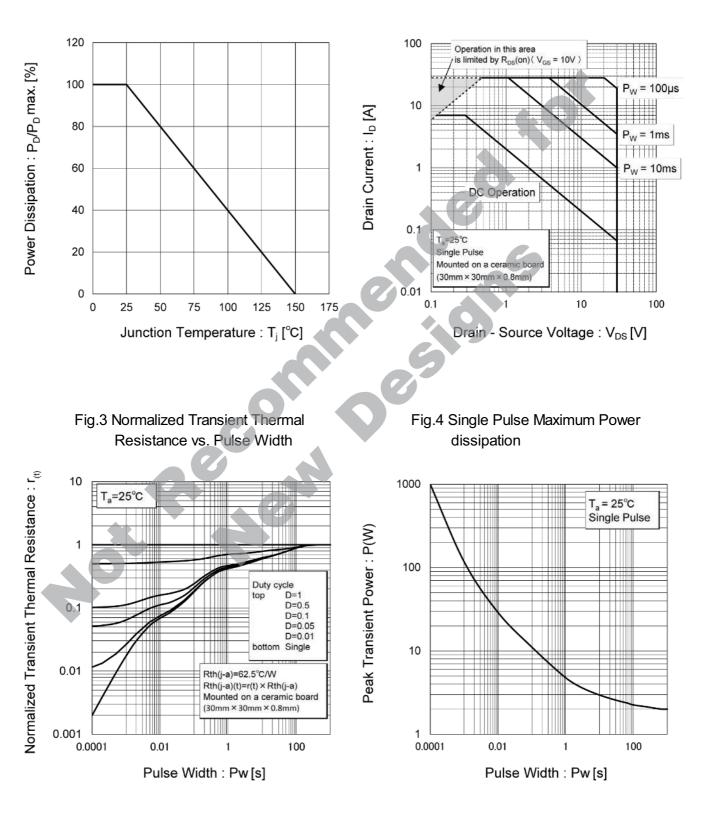


Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area



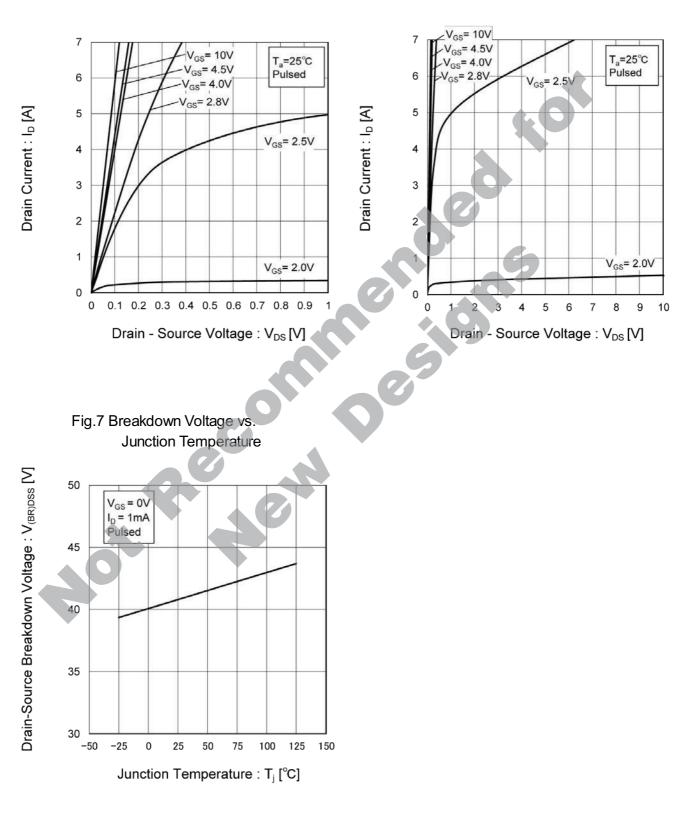


Fig.5 Typical Output Characteristics(I)

Fig.6 Typical Output Characteristics(II)



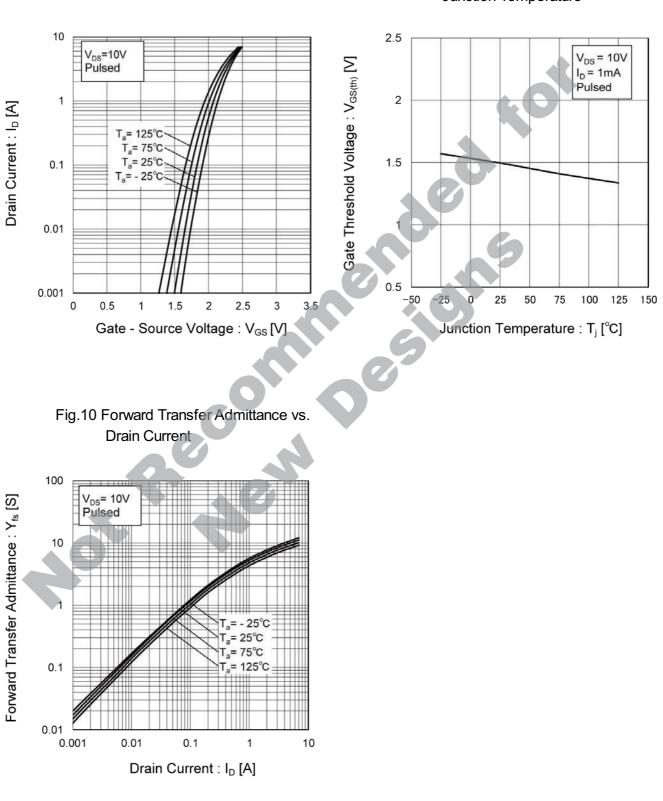
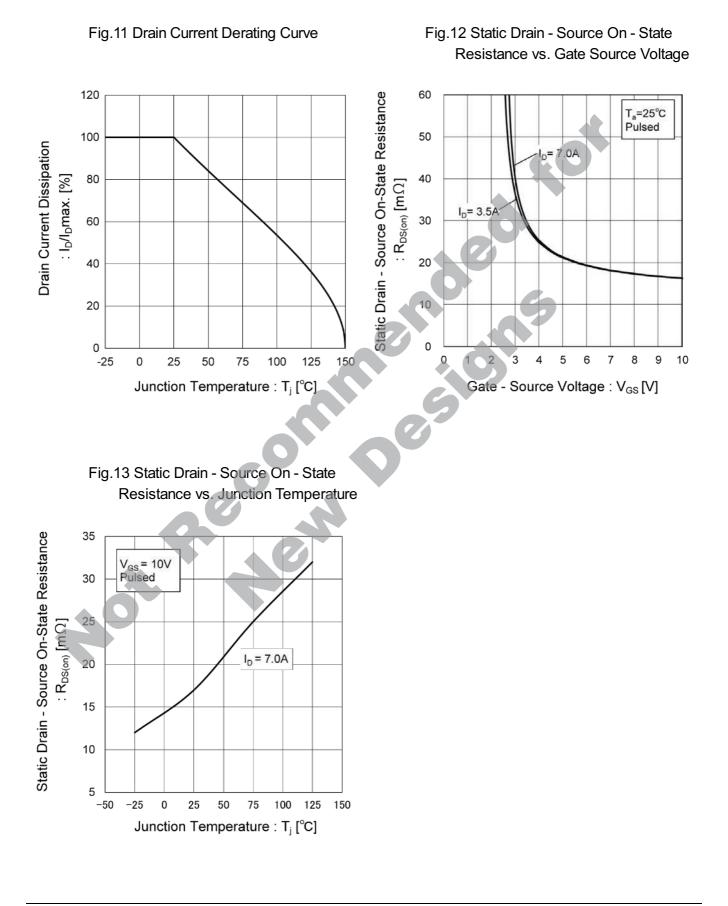
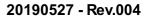


Fig.8 Typical Transfer Characteristics

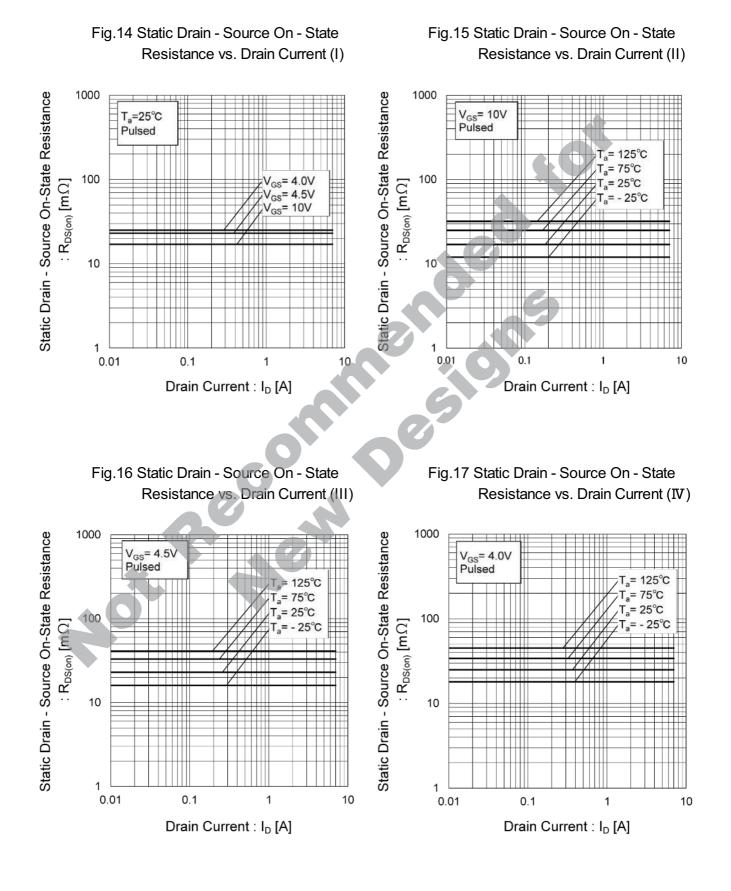
Fig.9 Gate Threshold Voltage vs. Junction Temperature





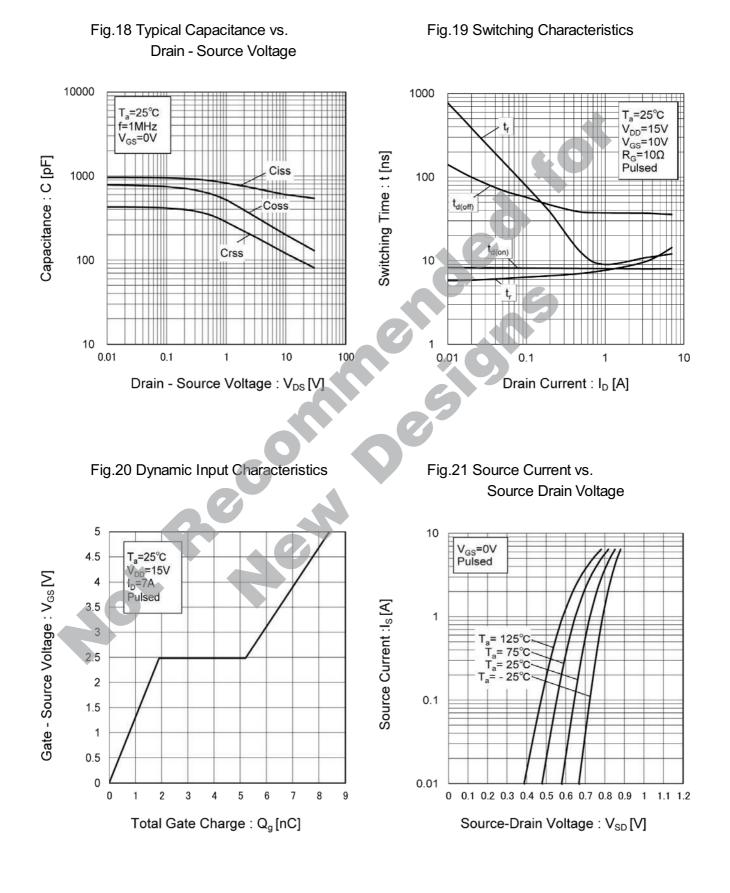


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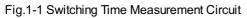


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•Measurement circuits <It is the same for the Tr1 and Tr2>



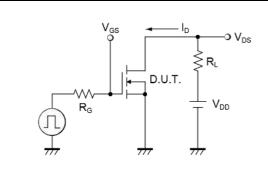


Fig.2-1 Gate Charge Measurement Circuit

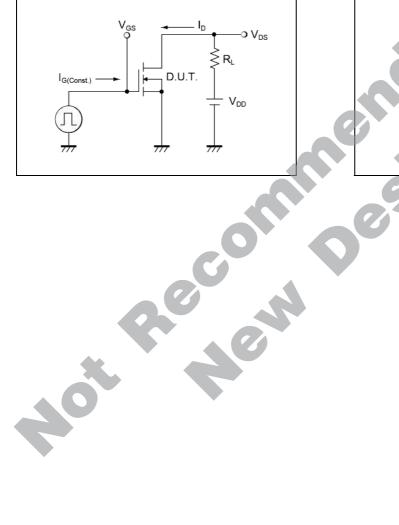
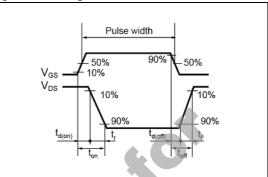
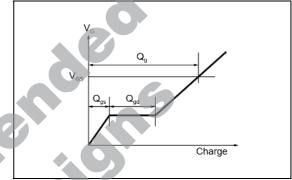


Fig.1-2 Switching Waveforms



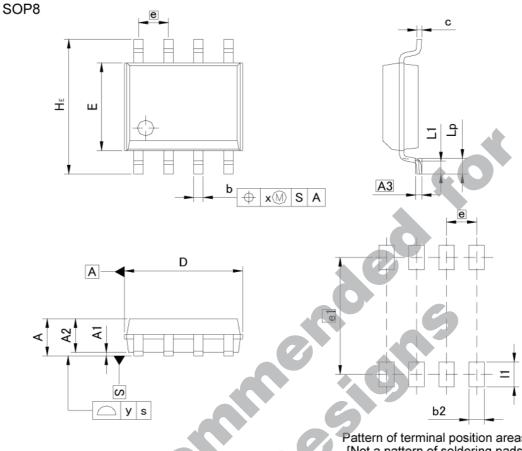






SP8K3FRA

Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIME	TERS	INC	HES
DIM	MIN	MAX	MIN	MAX
A		1.75		0.069
A1	0.1	5	0.0	006
A2	1.40	1.60	0.055	0.063
A3	0.2	5	0.0	10
b	0.30	0.50	0.012	0.020
c	0.10	0.30	0.004	0.012
D	4.80	5.20	0.189	0.205
E	3.75	4.05	0.148	0.159
е	1.2	7	0.0	50
HE	5.70	6.30	0.224	0.248
L1	0.40	0.60	0.016	0.024
Lp	0.65	0.85	0.026	0.033
x	and the second s		0.006	
У	0.1	0	0.0	04

DIM	MILIM	ETERS	INC	HES
	MIN	MAX	MIN	MAX
b2		0.65	ज्य	0.026
e1	5.15		0.1	203
11	77 2	1.15	27 6	0.045

11/11

Dimension in mm/inches

Roi



Notice

Precaution on using ROHM Products

 If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment (Note 1), aircraft/spacecraft, nuclear power controllers, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

(Note1) Medical Equipment Classification of the Specific Applications

JAPAN	USA	EU	CHINA
CLASSII		CLASS II b	CLASSⅢ
CLASSIV	CLASSⅢ	CLASSⅢ	CLASSII

2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:

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[b] Installation of redundant circuits to reduce the impact of single or multiple circuit failure

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 - [a] Use of our Products in any types of liquid, including water, oils, chemicals, and organic solvents
 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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A two-dimensional barcode printed on ROHM Products label is for ROHM's internal use only.

Precaution for Disposition

When disposing Products please dispose them properly using an authorized industry waste company.

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